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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

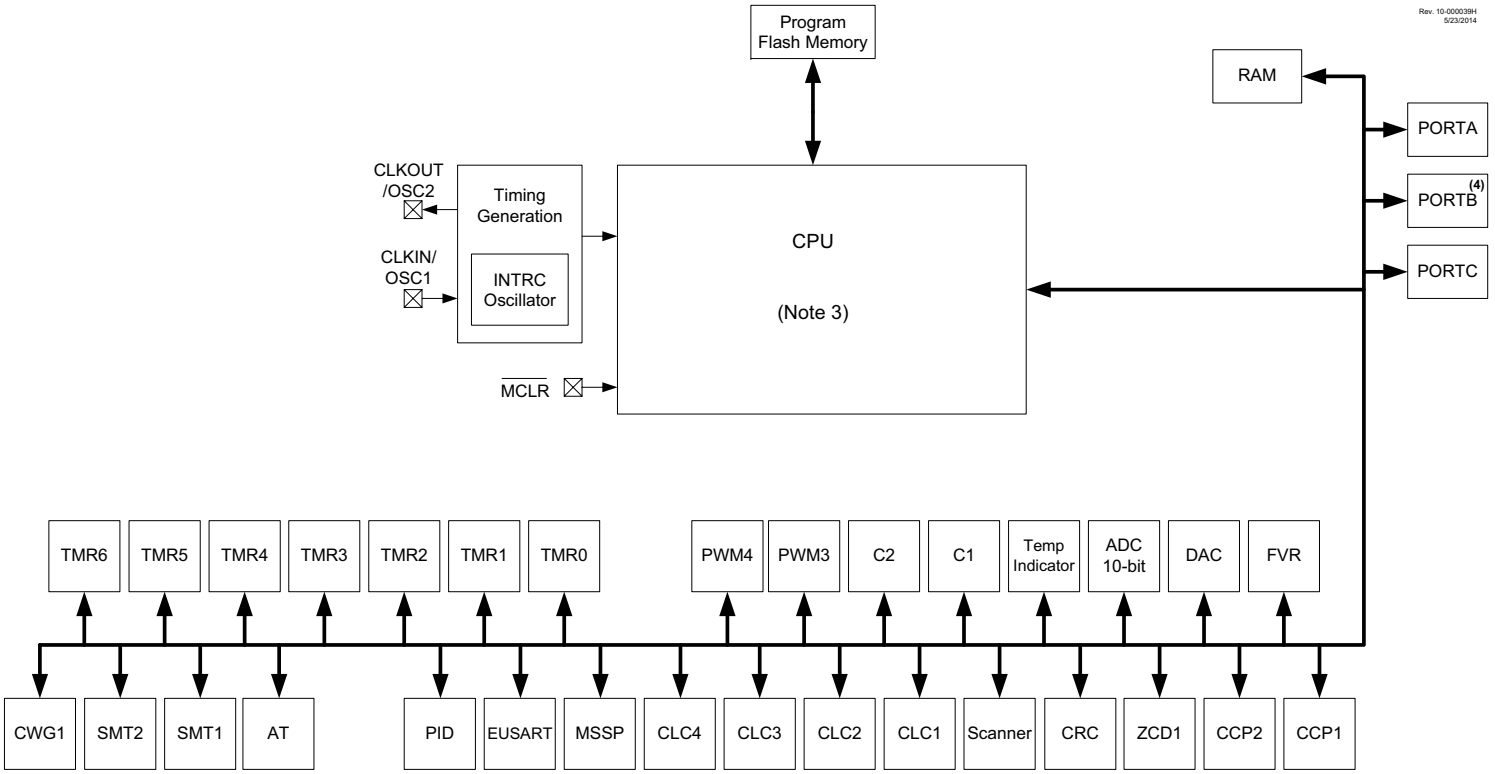
Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	18
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 12x10b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1619t-e-ss

TABLE 4: 20-PIN ALLOCATION TABLE (PIC16(L)F1619)

I/O	20-Pin PDIP, SOIC, SSOP	20-Pin UQFN	A/D	Reference	Comparator	Timers	CCP	CWG	ZCD	CLC	EUSART	SMT	Angular Timer	MSSP	PWM	High Current I/O	Interrupt	Pull-up	Basic
OUT(2)	—	—	—	—	C1OUT	—	CCP1	CWG1A	ZCD1OUT	CLC1OUT	DT(3)	—	—	SDO	PWM3OUT	—	—	—	—
	—	—	—	—	C2OUT	—	CCP2	CWG1B	—	CLC2OUT	CK	—	—	SCK(3)	PWM4OUT	—	—	—	—
	—	—	—	—	—	—	—	CWG1C	—	CLC3OUT	TX	—	—	—	—	—	—	—	—
	—	—	—	—	—	—	—	CWG1D	—	CLC4OUT	—	—	—	—	—	—	—	—	—

Note 1: Default peripheral input. Input can be moved to any other pin with the PPS input selection registers.
2: All pin outputs default to PORT latch data. Any pin can be selected as a digital peripheral output with the PPS output selection registers.
3: These peripheral functions are bidirectional. The output pin selections must be the same as the input pin selections.

FIGURE 1-1: PIC16(L)F1615/9 BLOCK DIAGRAM



Note 1: See applicable chapters for more information on peripherals.
2: See Table 1-1 for peripherals available on specific devices.
3: See Figure 2-1.
4: PIC16(L)F1619 only.

TABLE 1-2: PIC16(L)F1615 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RC1/AN5/C1IN1-/C2IN1-/ T4IN(1)/SMTSIG2(1)/SDI(1)	RC1	TTL/ST	CMOS/OD	General purpose I/O.
	AN5	AN	—	ADC Channel input.
	C1IN1-	AN	—	Comparator negative input.
	C2IN1-	AN	—	Comparator negative input.
	T4IN	TTL/ST	—	Timer4 input.
	SMTSIG2	TTL/ST	—	SMT2 signal input.
	SDI	CMOS	—	SPI data input.
RC2/AN6/C1IN2-/C2IN2-	RC2	TTL/ST	CMOS/OD	General purpose I/O.
	AN6	AN	—	ADC Channel input.
	C1IN2-	AN	—	Comparator negative input.
	C2IN2-	AN	—	Comparator negative input.
RC3/AN7/C1IN3-/C2IN3-/T5G(1)/ CCP2(1)/CLCIN0(1)/ATCC(1)/$\overline{SS}$	RC3	TTL/ST	—	General purpose input with IOC and WPU.
	AN7	AN	—	ADC Channel input.
	C1IN3-	AN	—	Comparator negative input.
	C2IN3-	AN	—	Comparator negative input.
	T5G	ST	—	Timer5 Gate input.
	CCP2	TTL/ST	CMOS/OD	Capture/Compare/PWM2.
	CLCIN0	ST	—	Configurable Logic Cell source input.
	ATCC	ST	—	Angular Timer Capture/Compare input.
	$\overline{SS}$	ST	—	Slave Select input.
RC4/T3G(1)/CLCIN1(1)/CK(1)/ HIC4	RC4	TTL/ST	CMOS/OD	General purpose I/O.
	T3G	TTL/ST	—	Timer3 Gate input.
	CLCIN1	ST	—	Configurable Logic Cell source input.
	CK	ST	CMOS	EUSART synchronous clock.
	HIC4	TTL	CMOS	High current I/O.
RC5/T3CKI(1)/CCP1(1)/RX(1)/ ATIN(1)/HIC5	RC5	TTL/ST	CMOS/OD	General purpose I/O.
	T3CKI	TTL/ST	—	Timer3 clock input.
	CCP1	TTL/ST	CMOS/OD	Capture/Compare/PWM1.
	RX	ST	—	EUSART asynchronous input.
	ATIN	TTL/ST	—	Angular Timer clock input.
	HIC5	TTL	CMOS	High current I/O.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C™ = Schmitt Trigger input with I^2C™ levels
HV = High Voltage XTAL = Crystal

Note 1: Default peripheral input. Input can be moved to any other pin with the PPS input selection registers.

2: All pin outputs default to PORT latch data. Any pin can be selected as a digital peripheral output with the PPS output selection registers. See Register 13-1.

2.1 Automatic Interrupt Context Saving

During interrupts, certain registers are automatically saved in shadow registers and restored when returning from the interrupt. This saves stack space and user code. See **Section 7.5 “Automatic Context Saving”**, for more information.

2.2 16-Level Stack with Overflow and Underflow

These devices have a hardware stack memory 15 bits wide and 16 words deep. A Stack Overflow or Underflow will set the appropriate bit (STKOVF or STKUNF) in the PCON register, and if enabled, will cause a software Reset. See section **Section 3.5 “Stack”** for more details.

2.3 File Select Registers

There are two 16-bit File Select Registers (FSR). FSRs can access all file registers and program memory, which allows one Data Pointer for all memory. When an FSR points to program memory, there is one additional instruction cycle in instructions using INDF to allow the data to be fetched. General purpose memory can now also be addressed linearly, providing the ability to access contiguous data larger than 80 bytes. There are also new instructions to support the FSRs. See **Section 3.6 “Indirect Addressing”** for more details.

2.4 Instruction Set

There are 49 instructions for the enhanced mid-range CPU to support the features of the CPU. See **Section 34.0 “Instruction Set Summary”** for more details.

TABLE 3-5: PIC16(L)F1615/9 MEMORY MAP, BANK 16-23

BANK 16		BANK 17		BANK 18		BANK 19		BANK 20		BANK 21		BANK 22		BANK 23	
800h	Core Registers (Table 3-1)	880h	Core Registers (Table 3-1)	900h	Core Registers (Table 3-1)	980h	Core Registers (Table 3-1)	A00h	Core Registers (Table 3-1)	A80h	Core Registers (Table 3-1)	B00h	Core Registers (Table 3-1)	B80h	Core Registers (Table 3-1)
80Bh		88Bh		90Bh		98Bh		A0Bh		A8Bh		B0Bh		B8Bh	
80Ch	AT1RESL	88Ch	AT1CLK	90Ch	Unimplemented Read as '0'	98Ch	Unimplemented Read as '0'	A0Ch	Unimplemented Read as '0'	A8Ch	Unimplemented Read as '0'	B0Ch	Unimplemented Read as '0'	B8Ch	Unimplemented Read as '0'
80Dh	AT1RESH	88Dh	AT1SIG												
80Eh	AT1MISSL	88Eh	AT1CSEL1												
80Fh	AT1MISSH	88Fh	AT1CC1L												
810h	AT1PERL	890h	AT1CC1H												
811h	AT1PERH	891h	AT1CCON1												
812h	AT1PHSL	892h	AT1CSEL2												
813h	AT1PHSH	893h	AT1CC2L												
814h	AT1CON0	894h	AT1CC2H												
815h	AT1CON1	895h	AT1CCON2												
816h	AT1IR0	896h	AT1CSEL2												
817h	AT1IE0	897h	AT1CC3L												
818h	AT1IR1	898h	AT1CC3H												
819h	AT1IE1	899h	AT1CCON3												
81Ah	AT1STPTL	89Ah													
81Bh	AT1STPTH														
81Ch	AT1ERRL														
81Dh	AT1ERRH														
86Fh		8EFh		96Fh		9EFh		A6Fh		AEFh		B6Fh		BEFh	
870h	Accesses 70h – 7Fh	8F0h	Accesses 70h – 7Fh	970h	Accesses 70h – 7Fh	9F0h	Accesses 70h – 7Fh	A70h	Accesses 70h – 7Fh	AF0h	Accesses 70h – 7Fh	B70h	Accesses 70h – 7Fh	BF0h	Accesses 70h – 7Fh
87Fh		8FFh		97Fh		9FFh		A7Fh		AFFh		B7Fh		BFFh	

Legend: = Unimplemented data memory locations, read as '0'.

10.0 FLASH PROGRAM MEMORY CONTROL

The Flash program memory is readable and writable during normal operation over the full VDD range. Program memory is indirectly addressed using Special Function Registers (SFRs). The SFRs used to access program memory are:

- PMCON1
- PMCON2
- PMDATL
- PMDATH
- PMADRL
- PMADRH

When accessing the program memory, the PMDATH:PMDATL register pair forms a 2-byte word that holds the 14-bit data for read/write, and the PMADRH:PMADRL register pair forms a 2-byte word that holds the 15-bit address of the program memory location being read.

The write time is controlled by an on-chip timer. The write/erase voltages are generated by an on-chip charge pump rated to operate over the operating voltage range of the device.

The Flash program memory can be protected in two ways; by code protection ($\overline{CP}$ bit in Configuration Words) and write protection (WRT<1:0> bits in Configuration Words).

Code protection ($\overline{CP}$ = 0)**(1)**, disables access, reading and writing, to the Flash program memory via external device programmers. Code protection does not affect the self-write and erase functionality. Code protection can only be reset by a device programmer performing a Bulk Erase to the device, clearing all Flash program memory, Configuration bits and User IDs.

Write protection prohibits self-write and erase to a portion or all of the Flash program memory, as defined by the bits WRT<1:0>. Write protection does not affect a device programmers ability to read, write or erase the device.

Note 1:	Code protection of the entire Flash program memory array is enabled by clearing the $\overline{CP}$ bit of Configuration Words.

10.1 PMADRL and PMADRH Registers

The PMADRH:PMADRL register pair can address up to a maximum of 16K words of program memory. When selecting a program address value, the MSB of the address is written to the PMADRH register and the LSB is written to the PMADRL register.

10.1.1 PMCON1 AND PMCON2 REGISTERS

PMCON1 is the control register for Flash program memory accesses.

Control bits RD and WR initiate read and write, respectively. These bits cannot be cleared, only set, in software. They are cleared by hardware at completion of the read or write operation. The inability to clear the WR bit in software prevents the accidental, premature termination of a write operation.

The WREN bit, when set, will allow a write operation to occur. On power-up, the WREN bit is clear. The WRERR bit is set when a write operation is interrupted by a Reset during normal operation. In these situations, following Reset, the user can check the WRERR bit and execute the appropriate error handling routine.

The PMCON2 register is a write-only register. Attempting to read the PMCON2 register will return all '0's.

To enable writes to the program memory, a specific pattern (the unlock sequence), must be written to the PMCON2 register. The required unlock sequence prevents inadvertent writes to the program memory write latches and Flash program memory.

10.2 Flash Program Memory Overview

It is important to understand the Flash program memory structure for erase and programming operations. Flash program memory is arranged in rows. A row consists of a fixed number of 14-bit program memory words. A row is the minimum size that can be erased by user software.

After a row has been erased, the user can reprogram all or a portion of this row. Data to be written into the program memory row is written to 14-bit wide data write latches. These write latches are not directly accessible to the user, but may be loaded via sequential writes to the PMDATH:PMDATL register pair.

Note:	If the user wants to modify only a portion of a previously programmed row, then the contents of the entire row must be read and saved in RAM prior to the erase. Then, new data and retained data can be written into the write latches to reprogram the row of Flash program memory. However, any unprogrammed locations can be written without first erasing the row. In this case, it is not necessary to save and rewrite the other previously programmed locations.

See Table 10-1 for Erase Row size and the number of write latches for Flash program memory.

TABLE 10-1: FLASH MEMORY ORGANIZATION BY DEVICE

Device	Row Erase (words)	Write Latches (words)
PIC16(L)F1615	32	32
PIC16(L)F1619		

10.6 Register Definitions: Flash Program Memory Control

REGISTER 10-1: PMDATL: PROGRAM MEMORY DATA LOW BYTE REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
PMDAT<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **PMDAT<7:0>**: Read/write value for Least Significant bits of program memory

REGISTER 10-2: PMDATH: PROGRAM MEMORY DATA HIGH BYTE REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	PMDAT<13:8>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **PMDAT<13:8>**: Read/write value for Most Significant bits of program memory

REGISTER 10-3: PMADRL: PROGRAM MEMORY ADDRESS LOW BYTE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PMADR<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **PMADR<7:0>**: Specifies the Least Significant bits for program memory address

REGISTER 10-4: PMADRH: PROGRAM MEMORY ADDRESS HIGH BYTE REGISTER

U-1	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—(1)	PMADR<14:8>						
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **Unimplemented:** Read as ‘1’

bit 6-0 **PMADR<14:8>**: Specifies the Most Significant bits for program memory address

Note 1: Unimplemented, read as ‘1’.

11.11 Register Definitions: CRC and Scanner Control

REGISTER 11-1: CRCCON0: CRC CONTROL REGISTER 0

R/W-0/0	R/W-0/0	R-0	R/W-0/0	U-0	U-0	R/W-0/0	R-0
EN	CRCGO	BUSY	ACCM	—	—	SHIFTM	FULL
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **EN:** CRC Enable bit
1 = CRC module is released from Reset
0 = CRC is disabled and consumes no operating current

bit 6 **CRCGO:** CRC Start bit
1 = Start CRC serial shifter
0 = CRC serial shifter turned off

bit 5 **BUSY:** CRC Busy bit
1 = Shifting in progress or pending
0 = All valid bits in shifter have been shifted into accumulator and EMPTY = 1

bit 4 **ACCM:** Accumulator Mode bit
1 = Data is augmented with zeros
0 = Data is not augmented with zeros

bit 3-2 **Unimplemented:** Read as ‘0’

bit 1 **SHIFTM:** Shift Mode bit
1 = Shift right (LSb)
0 = Shift left (MSb)

bit 0 **FULL:** Data Path Full Indicator bit
1 = CRCDATH/L registers are full
0 = CRCDATH/L registers have shifted their data into the shifter

REGISTER 11-2: CRCCON1: CRC CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
DLEN<3:0>				PLEN<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-4 **DLEN<3:0>:** Data Length bits
Denotes the length of the data word -1 (See Example 11-1)

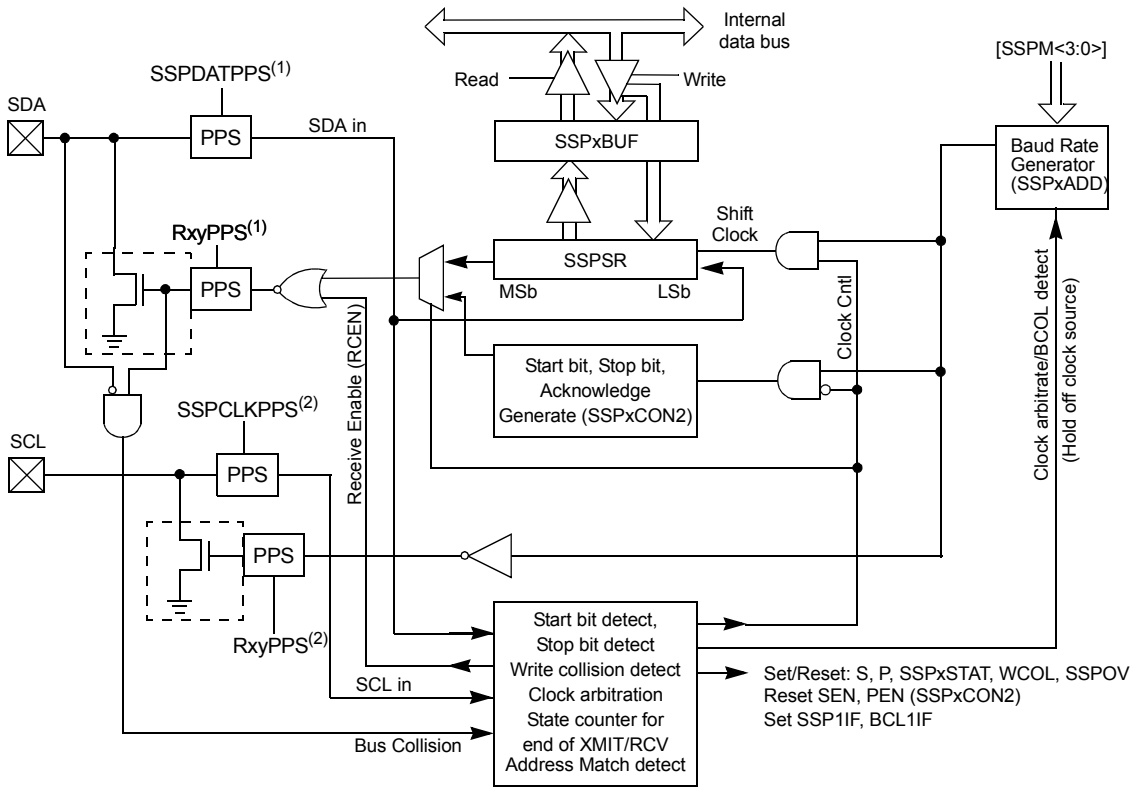
bit 3-0 **PLEN<3:0>:** Polynomial Length bits
Denotes the length of the polynomial -1 (See Example 11-1)

The I^2C interface supports the following modes and features:

- Master mode
- Slave mode
- Byte NACKing (Slave mode)
- Limited multi-master support
- 7-bit and 10-bit addressing
- Start and Stop interrupts
- Interrupt masking
- Clock stretching
- Bus collision detection
- General call address matching
- Address masking
- Address Hold and Data Hold modes
- Selectable SDA hold times

Figure 24-2 is a block diagram of the I^2C interface module in Master mode. Figure 24-3 is a diagram of the I^2C interface module in Slave mode.

FIGURE 24-2: MSSP BLOCK DIAGRAM (I^2C MASTER MODE)



Note 1: SDA pin selections must be the same for input and output.

2: SCL pin selections must be the same for input and output.

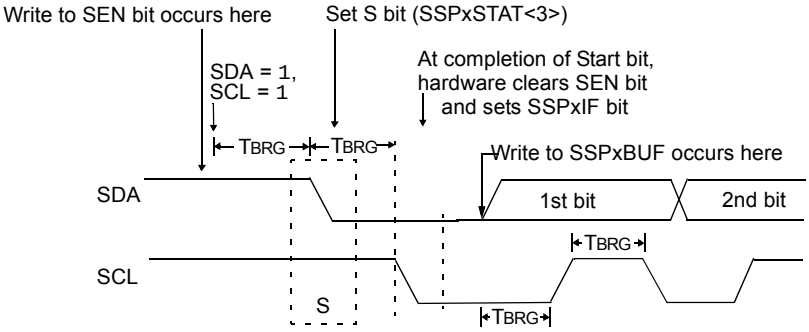
24.6.4 I²C MASTER MODE START CONDITION TIMING

To initiate a Start condition (Figure 24-26), the user sets the Start Enable bit, SEN bit of the SSPxCON2 register. If the SDA and SCL pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPxADD<7:0> and starts its count. If SCL and SDA are both sampled high when the Baud Rate Generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low while SCL is high is the Start condition and causes the S bit of the SSPxSTAT1 register to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPxADD<7:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit of the SSPxCON2 register will be automatically cleared by hardware; the Baud Rate Generator is suspended, leaving the SDA line held low and the Start condition is complete.

Note 1: If at the beginning of the Start condition, the SDA and SCL pins are already sampled low, or if during the Start condition, the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCL1IF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

2: The Philips I²C specification states that a bus collision cannot occur on a Start.

FIGURE 24-26: FIRST START BIT TIMING



25.1.2.8 Asynchronous Reception Set-up

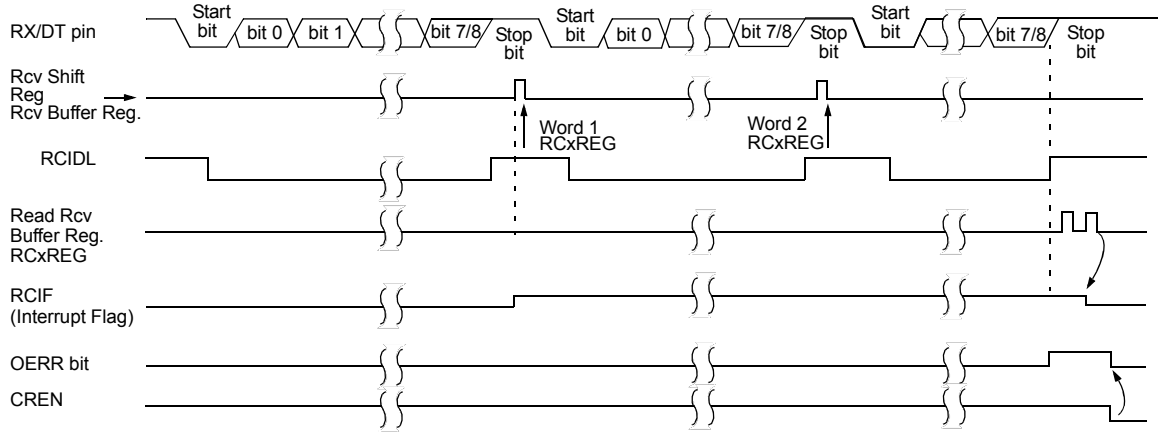
1. Initialize the SPxBRGH, SPxBRGL register pair and the BRGH and BRG16 bits to achieve the desired baud rate (see **Section 25.4 "EUSART Baud Rate Generator (BRG)"**).
2. Clear the ANSEL bit for the RX pin (if applicable).
3. Enable the serial port by setting the SPEN bit. The SYNC bit must be clear for asynchronous operation.
4. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
5. If 9-bit reception is desired, set the RX9 bit.
6. Enable reception by setting the CREN bit.
7. The RCIF interrupt flag bit will be set when a character is transferred from the RSR to the receive buffer. An interrupt will be generated if the RCIE interrupt enable bit was also set.
8. Read the RCxSTA register to get the error flags and, if 9-bit data reception is enabled, the ninth data bit.
9. Get the received eight Least Significant data bits from the receive buffer by reading the RCxREG register.
10. If an overrun occurred, clear the OERR flag by clearing the CREN receiver enable bit.

25.1.2.9 9-bit Address Detection Mode Set-up

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

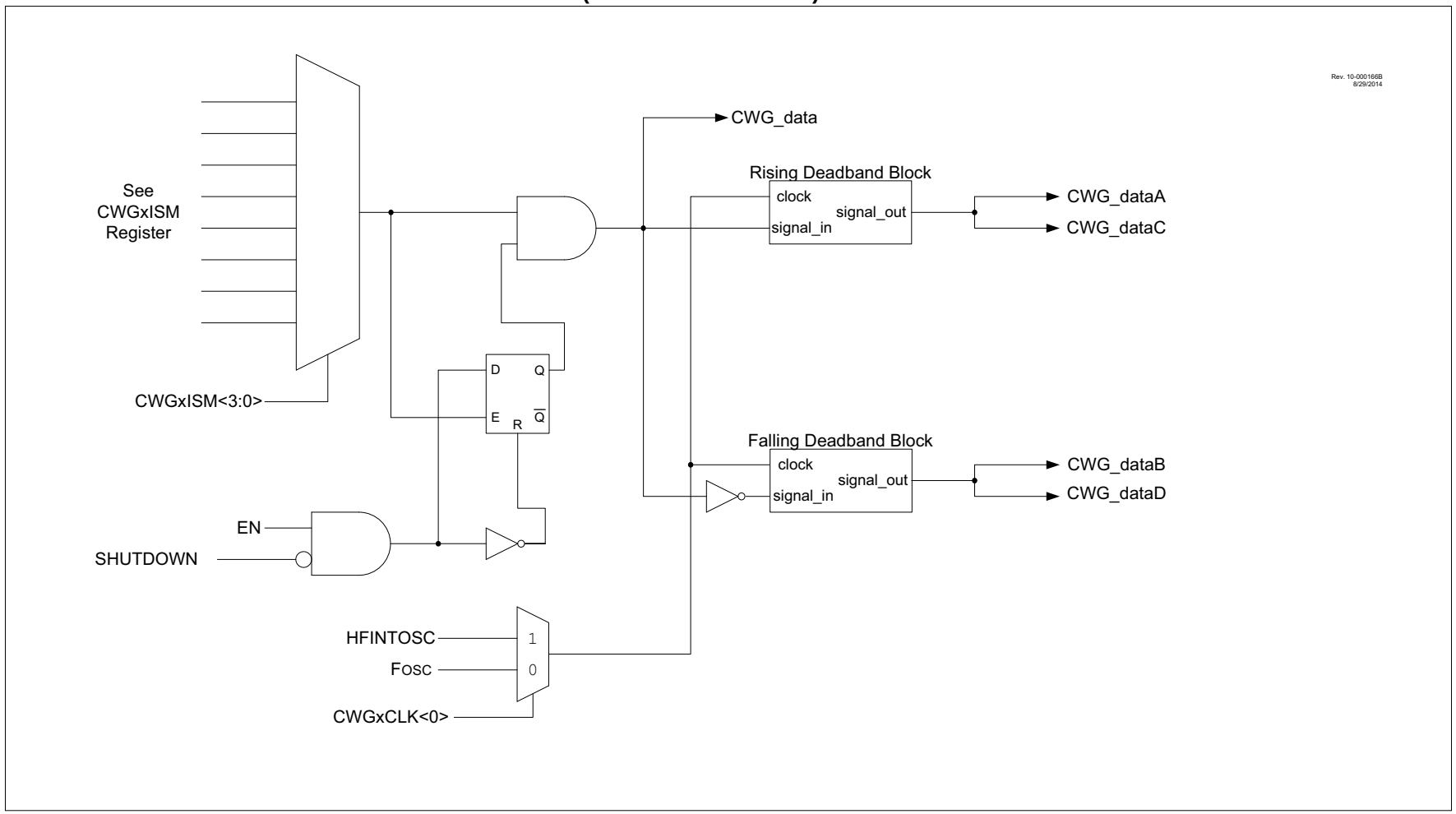
1. Initialize the SPxBRGH, SPxBRGL register pair and the BRGH and BRG16 bits to achieve the desired baud rate (see **Section 25.4 "EUSART Baud Rate Generator (BRG)"**).
2. Clear the ANSEL bit for the RX pin (if applicable).
3. Enable the serial port by setting the SPEN bit. The SYNC bit must be clear for asynchronous operation.
4. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
5. Enable 9-bit reception by setting the RX9 bit.
6. Enable address detection by setting the ADDEN bit.
7. Enable reception by setting the CREN bit.
8. The RCIF interrupt flag bit will be set when a character with the ninth bit set is transferred from the RSR to the receive buffer. An interrupt will be generated if the RCIE interrupt enable bit was also set.
9. Read the RCxSTA register to get the error flags. The ninth data bit will always be set.
10. Get the received eight Least Significant data bits from the receive buffer by reading the RCxREG register. Software determines if this is the device's address.
11. If an overrun occurred, clear the OERR flag by clearing the CREN receiver enable bit.
12. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and generate interrupts.

FIGURE 25-5: ASYNCHRONOUS RECEPTION



Note: This timing diagram shows three words appearing on the RX input. The RCxREG (receive buffer) is read after the third word, causing the OERR (overrun) bit to be set.

FIGURE 28-1: SIMPLIFIED CWG BLOCK DIAGRAM (HALF-BRIDGE MODE)



29.0 CONFIGURABLE LOGIC CELL (CLC)

The Configurable Logic Cell (CLCx) provides programmable logic that operates outside the speed limitations of software execution. The logic cell takes up to 16 input signals, and through the use of configurable gates, reduces the 16 inputs to four logic lines that drive one of eight selectable single-output logic functions.

Input sources are a combination of the following:

- I/O pins
- Internal clocks
- Peripherals
- Register bits

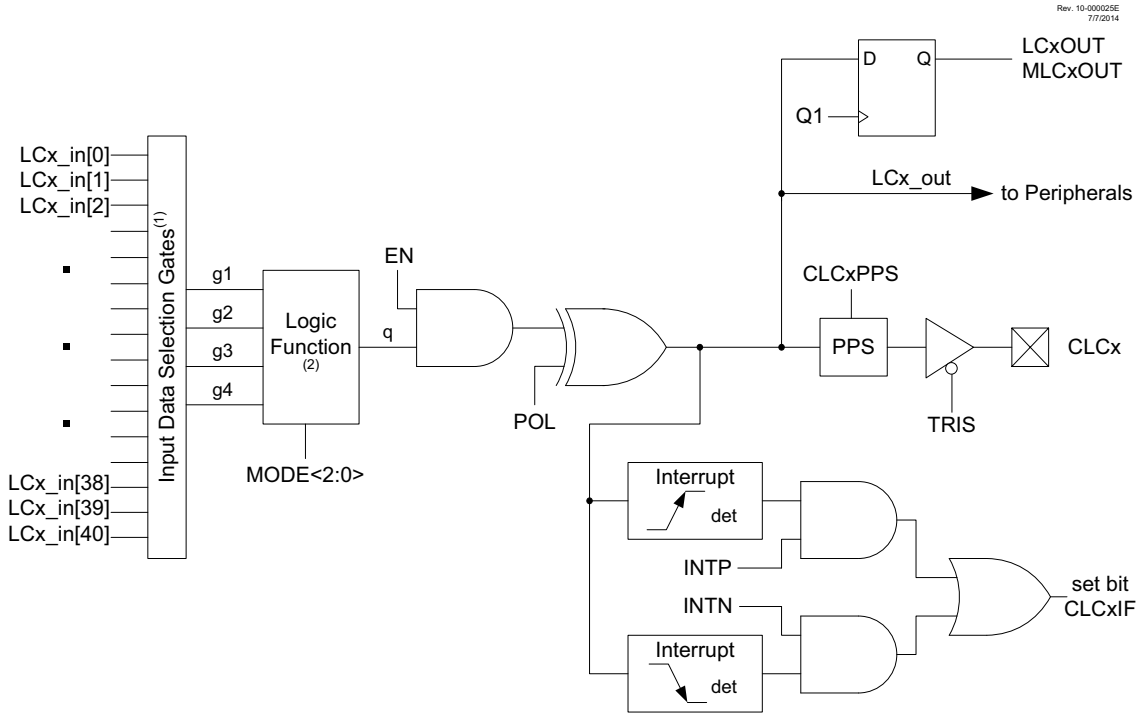
The output can be directed internally to peripherals and to an output pin.

Refer to Figure 29-1 for a simplified diagram showing signal flow through the CLCx.

Possible configurations include:

- Combinatorial Logic
  - AND
  - NAND
  - AND-OR
  - AND-OR-INVERT
  - OR-XOR
  - OR-XNOR
- Latches
  - S-R
  - Clocked D with Set and Reset
  - Transparent D with Set and Reset
  - Clocked J-K with Reset

FIGURE 29-1: CONFIGURABLE LOGIC CELL BLOCK DIAGRAM



Note 1: See Figure 29-2.
2: See Figure 29-3.

The variables in Equation 31-6 are as follows:

- MissP is the period between missing pulses
- PulseP is the period between input pulses
- ATxPHS(final) is the maximum value of the phase counter

This results in a phase clock output that pulses ATxRES+1 times every input pulse, and a phase counter that increments from 0 to ATxPHS(final) over the entire time between the missing pulses.

Similar to Single-Pulse mode, this allows for triggered events to occur at fixed phase angles in the signal's period where the period is defined as the time between missing pulses. An example of multi-pulse operation is illustrated in the timing diagram of Figure 31-5, which also demonstrates what happens as a result of variations in the input signal period.

REGISTER 31-2: ATxCON1: ANGULAR TIMER CONTROL 1 REGISTER

U-0	R/W-0/0	U-0	R/W-0/0	U-0	R/W-0/0	R-0/0	R-0/0
—	PHP	—	PRP	—	MPP	ACCS	VALID
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7 **Unimplemented:** Read as ‘0’

bit 6 **PHP:** Phase Clock Output Polarity bit
1 = Phase clock output is active-low
0 = Phase clock output is active-high

bit 5 **Unimplemented:** Read as ‘0’

bit 4 **PRP:** Period Clock Output Polarity bit
1 = Period clock output is active-low
0 = Period clock output is active-high

bit 3 **Unimplemented:** Read as ‘0’

bit 2 **MPP:** Missing Pulse Output Polarity bit
1 = Missing pulse output is active-low
0 = Missing pulse output is active-high

bit 1 **ACCS:** Acceleration Sign bit
1 = The value currently in ATxPER is less than the previous value
0 = The value currently in ATxPER is greater than or equal to the previous value

bit 0 **VALID:** Valid Measurement bit
1 = Sufficient input cycles have occurred to make ATxPER and ATxPHS valid.
0 = The values in ATxPER and ATxPHS are not valid; not enough input cycles have occurred

REGISTER 32-17: PIDxZ1U: PID Z1 UPPER REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0
—	—	—	—	—	—	—	Z116
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-1 **Unimplemented:** Read as ‘0’

bit 0 **Z116:** Bit 16 of Z1. In PID mode, Z1 is the value of the error (IN minus SET) from the previous iteration of the PID control loop.

REGISTER 32-18: PIDxZ1H: PID Z1 HIGH REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
Z1<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-0 **Z1<15:8>:** Bits <15:8> of Z1. In PID mode, Z1 is the value of the error (IN minus SET) from the previous iteration of the PID control loop.

REGISTER 32-19: PIDxZ1L: PID Z1 LOW REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
Z1<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-0 **Z1<7:0>:** Bits <7:0> of Z1. In PID mode, Z1 is the value of the error (IN minus SET) from the previous iteration of the PID control loop.

TABLE 35-2: SUPPLY CURRENT (I_{DD})(1,2) (CONTINUED)

PIC16LF1615/9		Standard Operating Conditions (unless otherwise stated)					
PIC16F1615/9							
Param. No.	Device Characteristics	Min.	Typ†	Max.	Units	Conditions	
						V_{DD}	Note
D019		—	1.6	5.0	mA	3.0	F_{OSC} = 32 MHz, HFINTOSC
		—	1.9	6.0	mA	3.6	
D019		—	1.6	5.0	mA	3.0	F_{OSC} = 32 MHz, HFINTOSC
		—	1.9	6.0	mA	5.0	
D020A		—	1.6	5.0	mA	3.0	F_{OSC} = 32 MHz, External Clock (ECH), High-Power mode
		—	1.9	6.0	mA	3.6	
D020A		—	1.6	5.0	mA	3.0	F_{OSC} = 32 MHz, External Clock (ECH), High-Power mode
		—	1.9	6.0	mA	5.0	
D020B		—	6	16	µA	1.8	F_{OSC} = 32 kHz, External Clock (ECL), Low-Power mode
		—	8	22	µA	3.0	
D020B		—	13	43	µA	2.3	F_{OSC} = 32 kHz, External Clock (ECL), Low-Power mode
		—	15	55	µA	3.0	
		—	16	57	µA	5.0	
D020C		—	19	40	µA	1.8	F_{OSC} = 500 kHz, External Clock (ECL), Low-Power mode
		—	32	60	µA	3.0	
D020C		—	31	60	µA	2.3	F_{OSC} = 500 kHz, External Clock (ECL), Low-Power mode
		—	38	90	µA	3.0	
		—	44	100	µA	5.0	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The test conditions for all I_{DD} measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to V_{SS}; $\overline{MCLR}$ = V_{DD}; WDT disabled.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

Note: Unless otherwise noted, VIN = 5V, FOSC = 500 kHz, CIN = 0.1 µF, TA = 25°C.

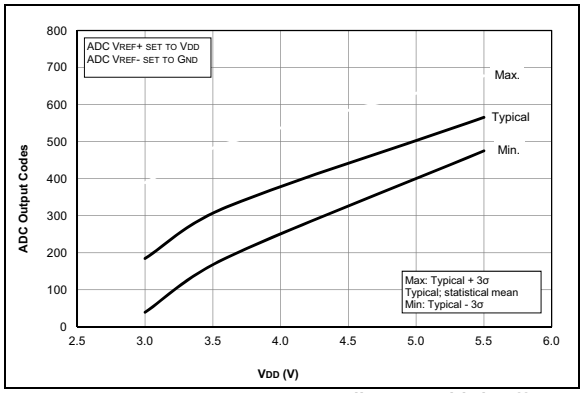


FIGURE 36-79: *Temp. Indicator Initial Offset, High Range, Temp. = 20°C, PIC16F1615/9 Only.*

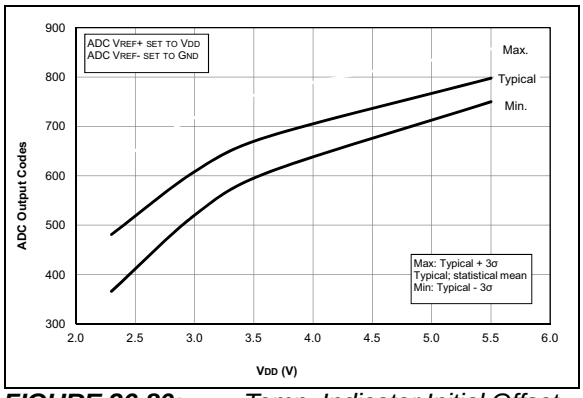


FIGURE 36-80: *Temp. Indicator Initial Offset, Low Range, Temp. = 20°C, PIC16F1615/9 Only.*

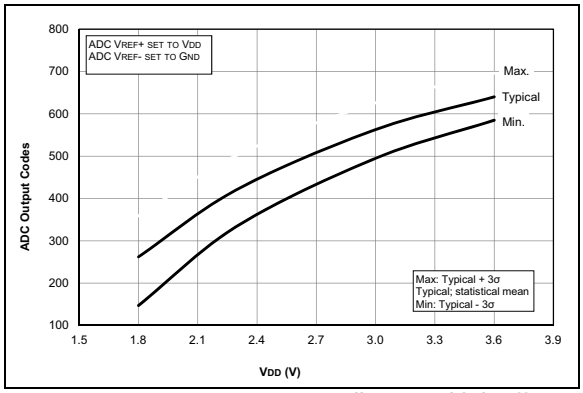


FIGURE 36-81: *Temp. Indicator Initial Offset, Low Range, Temp. = 20°C, PIC16LF1615/9 Only.*

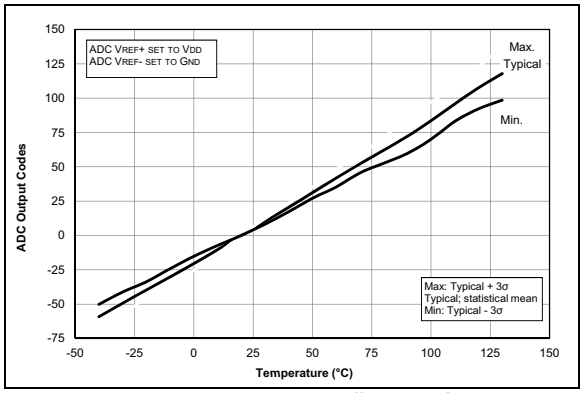


FIGURE 36-82: *Temp. Indicator Slope Normalized to 20°C, High Range, VDD = 5.5V, PIC16F1615/9 Only.*

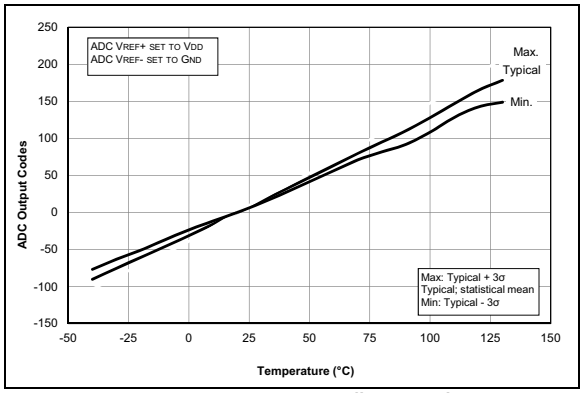


FIGURE 36-83: *Temp. Indicator Slope Normalized to 20°C, High Range, VDD = 3.0V, PIC16F1615/9 Only.*

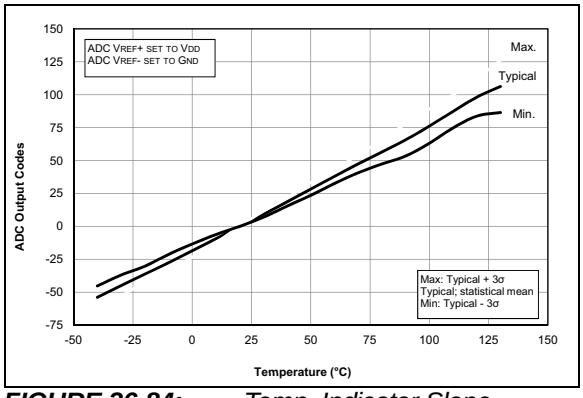


FIGURE 36-84: *Temp. Indicator Slope Normalized to 20°C, Low Range, VDD = 3.0V, PIC16F1615/9 Only.*

38.2 Package Details

The following sections give the technical details of the packages.

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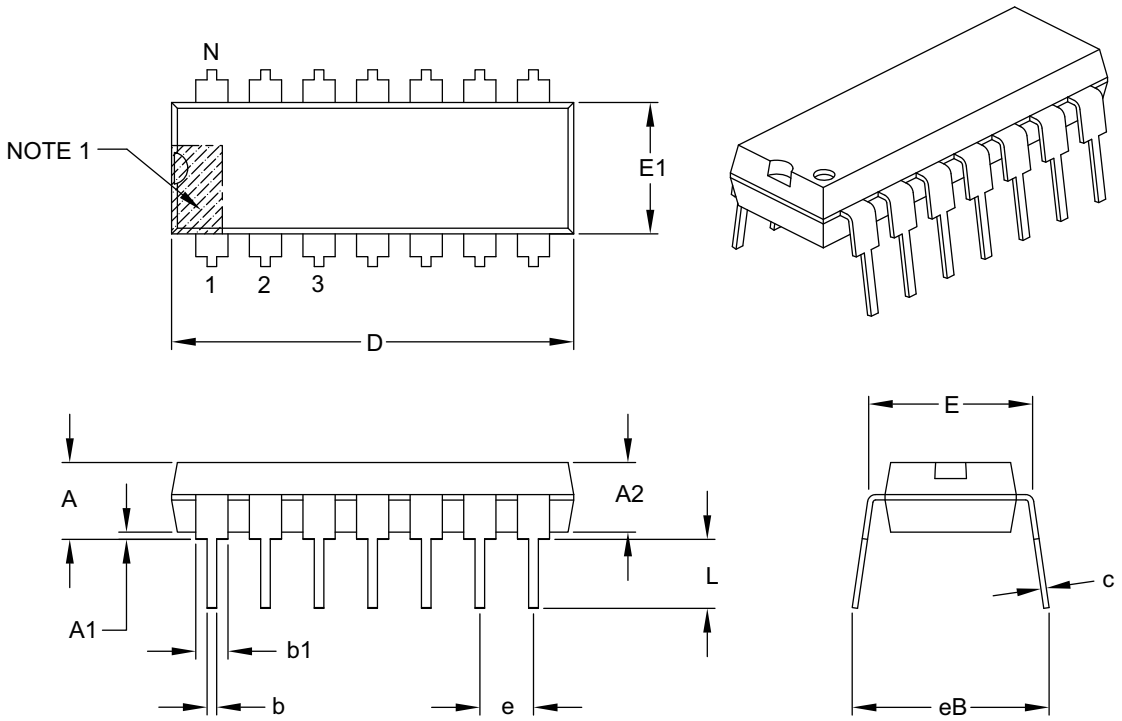
14-Lead Plastic Dual In-Line (P) – 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		14	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.735	.750	.775
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.045	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

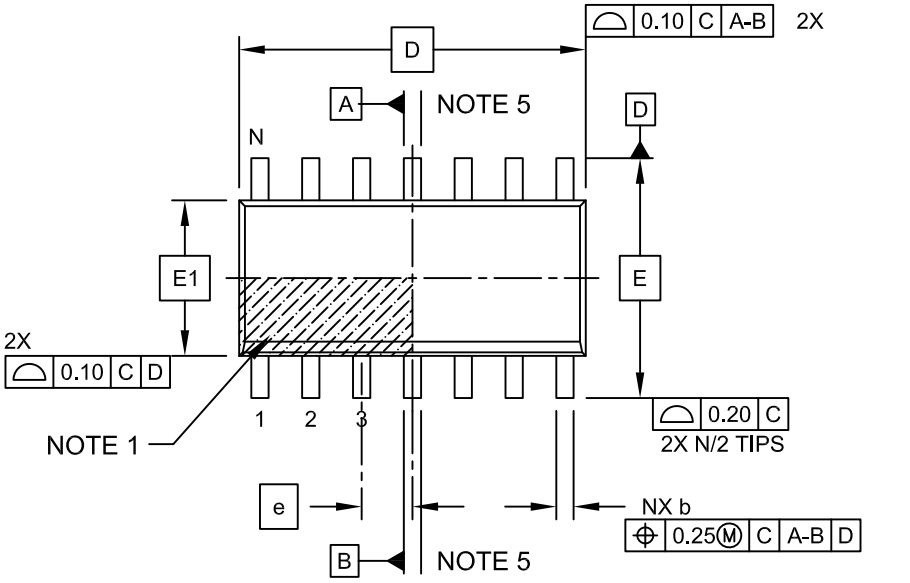
1. Pin 1 visual index feature may vary, but must be located with the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

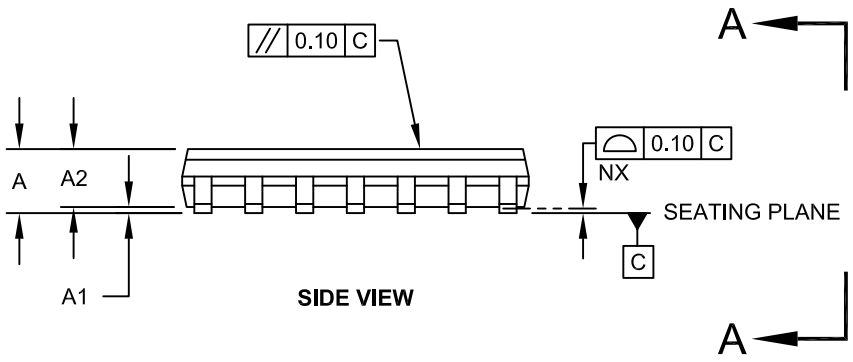
Microchip Technology Drawing C04-005B

14-Lead Plastic Small Outline (SL) - Narrow, 3.90 mm Body [SOIC]

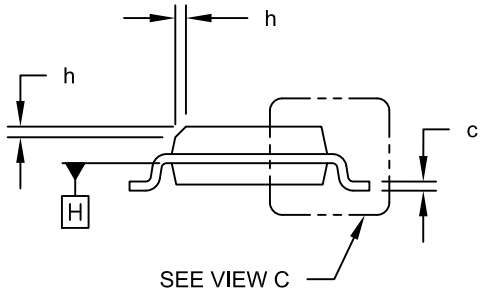
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



TOP VIEW



SIDE VIEW



VIEW A-A

Microchip Technology Drawing No. C04-065C Sheet 1 of 2